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Ferrite cores - Guidelines on dimensions and the limits of surface irregularities - Part 4: RM-cores (IEC 63093-4:2019) STANDARD PREVIEW

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Ferrite cores - Guidelines on dimensions and the limits of surface irregularities - Part 4: RM-cores

Ta slovenski standard je istoveten z: EN IEC 63093-4:2019

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EUROPEAN STANDARD NORME EUROPÉENNE EUROPÄISCHE NORM **EN IEC 63093-4**

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English Version

Ferrite cores - Guidelines on dimensions and the limits of surface irregularities - Part 4: RM-cores (IEC 63093-4:2019)

Noyaux ferrites - Lignes directrices relatives aux dimensions et aux limites des irrégularités de surface - Partie 4: Noyaux RM (IEC 63093-4:2019)

Ferritkerne - Richtlinien zu Maßen und Grenzen von Oberflächenbeschädigungen - Teil 4: RM-Kerne (IEC 63093-4:2019)

This European Standard was approved by CENELEC on 2019-04-12. CENELEC members are bound to comply with the CEN/CENELEC Internal Regulations which stipulate the conditions for giving this European Standard the status of a national standard without any alteration.

Up-to-date lists and bibliographical references concerning such national standards may be obtained on application to the CEN-CENELEC Management Centre or to any CENELEC member.

This European Standard exists in three official versions (English, French, German). A version in any other language made by translation under the responsibility of a CENELEC member into its own language and notified to the CEN-CENELEC Management Centre has the same status as the official versions.

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European Committee for Electrotechnical Standardization Comité Européen de Normalisation Electrotechnique Europäisches Komitee für Elektrotechnische Normung

CEN-CENELEC Management Centre: Rue de la Science 23, B-1040 Brussels

EN IEC 63093-4:2019 (E)

European foreword

The text of document 51/1265/FDIS, future edition 1 of IEC 63093-4, prepared by IEC/TC 51 "Magnetic components, ferrite and magnetic powder materials" was submitted to the IEC-CENELEC parallel vote and approved by CENELEC as EN IEC 63093-4:2019.

The following dates are fixed:

IEC 62317-2

- latest date by which the document has to be implemented at national level by publication of an identical national standard or by endorsement
- latest date by which the national standards conflicting with the document have to be withdrawn (dow) 2022-04-12

This document supersedes EN 60424-2:2016, EN 62317-4:2005.

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Endorsement notice

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The text of the International Standard IEC 63093-4:2019 was approved by CENELEC as a European Standard without any modification.

In the official version, for Bibliography, the following notes have to be added for the standards indicated:

NOTE

IEC 60424-2:2015	NOTE	Harmonized as EN 60424-2:2016 (not modified)
IEC 62044-2	NOTE	Harmonized as EN 62044-2

Harmonized as EN 62317-2

EN IEC 63093-4:2019 (E)

Annex ZA

(normative)

Normative references to international publications with their corresponding European publications

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

NOTE 1 Where an International Publication has been modified by common modifications, indicated by (mod), the relevant EN/HD applies.

NOTE 2 Up-to-date information on the latest versions of the European Standards listed in this annex is available here: www.cenelec.eu.

<u>Publication</u>	<u>Year</u>	<u>Title</u>	EN/HD	<u>Year</u>
IEC 60205	iT	Calculation of the effective parameters of magnetic piece parts RD PREVI		-
IEC 60401-1	-	Terms and nomenclature for cores made of magnetically soft ferrites - Part 1: Term used for physical irregularities		-
IEC 60424-1	https://sta	Ferrite cores - Guidelines on the limits of surface irregularities Part 1.5 General specification abovest-en-icc-63093-4-2019	of EN 60424-1 47d9-beb4-	-

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IEC 63093-4

Edition 1.0 2019-03

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INTERNATIONAL ELECTROTECHNICAL COMMISSION

FERRITE CORES – GUIDELINES ON DIMENSIONS AND THE LIMITS OF SURFACE IRREGULARITIES

Part 4: RM-cores

FORFWORD

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International Standard IEC 63093-4 has been prepared by IEC technical committee 51: Magnetic components, ferrite and magnetic powder materials.

This first edition cancels and replaces the first edition of IEC 62317-4 published in 2005 and the second edition of IEC 60424-2 published in 2015. This edition constitutes a technical revision.

This edition includes the following significant technical changes with respect to IEC 62317-4:2005 and IEC 60424-2:2015:

- a) IEC 63093-4 integrates the contents of IEC 62317-4:2005 and IEC 60424-2:2015;
- b) IEC 60424-2:2015, Table 2, has been included in Annex C as Table C.1.

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The text of this International Standard is based on the following documents:

FDIS	Report on voting
51/1265/FDIS	51/1275/RVD

Full information on the voting for the approval of this International Standard can be found in the report on voting indicated in the above table.

This document has been drafted in accordance with the ISO/IEC Directives, Part 2.

A list of all parts in the IEC 63093 series, published under the general title Ferrite cores – Guidelines on dimensions and the limits of surface irregularities, can be found on the IEC website.

The committee has decided that the contents of this document will remain unchanged until the stability date indicated on the IEC website under "http://webstore.iec.ch" in the data related to the specific document. At this date, the document will be

- reconfirmed,
- withdrawn,
- replaced by a revised edition, or
- amended.

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FERRITE CORES – GUIDELINES ON DIMENSIONS AND THE LIMITS OF SURFACE IRREGULARITIES

Part 4: RM-cores

1 Scope

This part of IEC 63093 specifies the dimensions that are of importance for mechanical interchangeability for a preferred range of RM-cores and low-profile RM-cores made of ferrite, and the locations of their terminal pins on a 2,54 mm printed wiring grid in relation to the base outlines of the cores. It also gives guidance on allowable limits of surface irregularities applicable to RM-cores in accordance with the relevant generic specification.

The selection of core sizes for this document is based on the philosophy of including those sizes which are industrial standards, either by inclusion in a national standard, or by broadbased use in industry.

This document is a specification useful in the negotiations between ferrite core manufacturers and customers about surface irregularities. ARD PREVIEW

The general considerations that the design of this range of cores is based upon are given in Annex A.

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2 Normative references rds.iteh.ai/catalog/standards/sist/0769fd53-d23e-47d9-beb4-ca4f8156cabe/sist-en-iec-63093-4-2019

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 60205, Calculation of the effective parameters of magnetic piece parts

IEC 60401-1, Terms and nomenclature for cores made of magnetically soft ferrites – Part 1: Terms used for physical irregularities

IEC 60424-1, Ferrite cores – Guidelines on the limits of surface irregularities – Part 1: General specification

3 Terms and definitions

For the purposes of this document, the terms and definitions given in IEC 60401-1 and IEC 60424-1 apply.

ISO and IEC maintain terminological databases for use in standardization at the following addresses:

- IEC Electropedia: available at http://www.electropedia.org/
- ISO Online browsing platform: available at http://www.iso.org/obp

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4 Primary dimensions

4.1 General

Compliance with the following requirements ensures mechanical interchangeability of complete assemblies and wound coil formers.

4.2 Dimensions of RM-cores

4.2.1 Principal dimensions

The principal dimensions of RM-cores shall be as given in Table 1 and those of the low-profile RM-cores shall be as given in Table 2. See also Figure 1 and Figure 2.

4.2.2 Effective parameter and A_{min} values

The effective parameter values for cores having the dimensions given in 4.2.1 are as shown in Table 3 and Table 4. The definitions of effective parameters and their calculations shall be as given in IEC 60205.

4.3 Main dimensions for coil formers

4.3.1 Shape of coil former and pin numbering

When the coil former is viewed from the pin side, the pins shall be numbered in a clockwise direction. Pin 1 shall be a corner pin, or the pin immediately to the right of a corner, and closest to the base outline.

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For asymmetrical arrangements, pin 1 shall be at the side with the largest number of pins. The coil former shall show an asymmetry, which shall preferably be visible (or detectable) when the assembled inductor is held with the pins downwards. This asymmetry shall clearly indicate pin 1. For pin numbering of recommended core patterns and for recommended asymmetrical pin arrangements, see 4.4.

NOTE It is not required that the pin numbers be marked on the coil former.

4.3.2 Dimensions of coil formers for RM-cores for the primary standard

The dimensions specified in Table 7 and Table 8 are illustrated in Figure 5.

4.3.3 RM-cores intended particularly for power applications

These coil formers are intended for use with cores RM 6-S, RM 8, RM 10, RM 12 and RM 14A, all without centre holes. Each is provided with twelve terminal pins except for the RM 6-S coil former, which has only eight.

Figure 7 shows the features specific to this format and the corresponding dimensions are given in Table 9.

4.4 Pin locations and base outlines

These shall be as shown in Figure 6 and Figure 8 (for power applications), in which the base is viewed from the pin side, i.e. from the underside of the printed wiring boards.

The pins should fit into holes, the nominal hole diameter being:

- 1 mm when the shortest distance between pins is 2,54 mm;
- 1,3 mm when the shortest distance between pins is 2,54 $\sqrt{2}$ mm or more.